Current Pipeline of Prospective Investments

The list presented here is drawn from a broader pool of targeted candidates the Team has been tracking. They represent the type and stage of potential investments the Fund is actively evaluating and conducting diligence. Each company exhibits distinctive, high value operational and technological attributes that make them compelling prospects. They will be discussed in greater detail when appropriate.

Tech Sector	**Potential Investment** (M = million)	**Highlights**
SiC Wafers Maker	USD 8.0M ~ 10.0M	Funding is needed to expand production of existing technology to meet growing demand, and to refine next-phase products where samples are being verified by major foundry.
Optical Lens Module Maker	USD 12.0M	Funding is needed to establish production to meet demand for new products. Founder is executive of a Taiwanese listed company.
NPU IC Design	USD 15.0M ~ 25.0M	Funding is needed to establish production. Has in place strategic partnership with leading tech enterprises in joint-marketing. The tech team is led by veteran IC design engineers from a Mag Seven company.
Semiconductor/Metal Composite Heat Dispersion	USD 15.0M	Products include critical upstream materials for advanced processes of semiconductor foundry. Sample verification with clients is underway.
Electroplating Manufacturer	USD 20M	Currently listed on the TPEx Venture Board, the company is seeking to expand production to meet demand. This is one of

		the few instances where the Fund would consider joining an SPO.
Optical IC Design Company	USD 30M	Funding is needed to expand production. Its primary clients are the world's largest optical module companies. Company has OTC board listing plans in 2027.
Substrate Material Manufacturer	USD 30M ~ 50M	The amount stated represents one fourth of total funding needed for a substrate material plant in Japan. The Taiwan parent supplies substrates to AI and ASIC chip packaging facilities in Taiwan; this project is intended to meet rising demand in Japan.